TOSHIBA LED Lamp InGaAlP Red Light Emission

TLRH190P

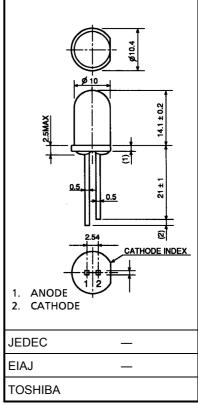
Panel Circuit Indicator

- 10 mm diameter
- InGaAlP red LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity red light emission Recommended forward current: IF = 1~20mA (DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- High power luminous intensity
- Without stand-offs
- Applications: Suitable for outdoor message signboard, safety equipment.

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Forward current (DC)	IF	50	mA
Reverse voltage	V_{R}	4	V
Power dissipation	P _D	125	mW
Operating temperature range	T _{opr}	-30~85	°C
Storage temperature range	T _{stg}	−40~120	°C

Unit in mm



Weight: 1.0 g

Electrical And Optical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition		Min	Тур.	Max	Unit
Forward voltage		V _F	I _F = 20 mA		_	1.9	2.5	V
Reverse current		I _R	V _R = 4 V		_	_	50	μΑ
Luminous intensity	TLRH190P	- I _V	I _F = 20 mA	(Note)	4760	19000	_	mcd
	TLRH190P (WX)				8500	_	41400	
Peak emission wavelength		λ _P	I _F = 20 mA		_	644	_	nm
Spectral line half width		Δλ	I _F = 20 mA		_	18	_	nm
Dominant wavelength		λ _d	I _F = 20mA		_	630	_	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity. Measurement tolerance for each limit is $\pm 15\%$.

V: 5600–11200mcd, W: 10000–20000mcd, X: 18000–36000mcd.

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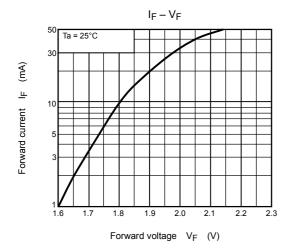
Precaution

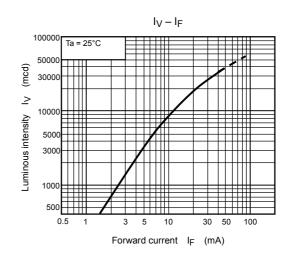
Please be careful of the followings

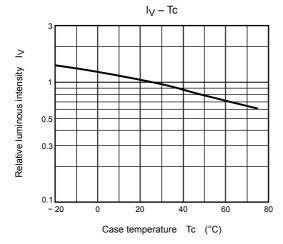
- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: Up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

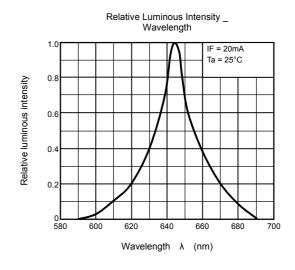
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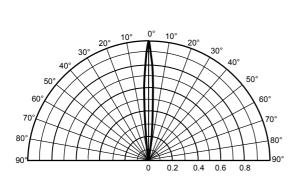
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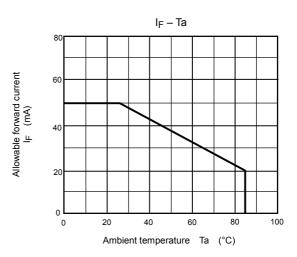






Radiation Pattern

 $T_a = 25 \,^{\circ}C$



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